PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
MUX36D08IDWR	Active	Production	SOIC (DW) | 28	1000 | LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36D08D
MUX36D08IDWR.B	Active	Production	SOIC (DW) | 28	1000 | LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36D08D
MUX36D08IDWRG4	Active	Production	SOIC (DW) | 28	1000 | LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36D08D
MUX36D08IDWRG4.B	Active	Production	SOIC (DW) | 28	1000 | LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36D08D
MUX36D08IPW	Active	Production	TSSOP (PW) | 28	50 | TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36D080A
MUX36D08IPW.B	Active	Production	TSSOP (PW) | 28	50 | TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36D080A
MUX36D08IPWR	Active	Production	TSSOP (PW) | 28	2000 | LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36D080A
MUX36D08IPWR.B	Active	Production	TSSOP (PW) | 28	2000 | LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36D080A
MUX36D08IPWRG4	Active	Production	TSSOP (PW) | 28	2000 | LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36D080A
MUX36D08IPWRG4.B	Active	Production	TSSOP (PW) | 28	2000 | LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36D080A
MUX36D08IRSNR	Active	Production	QFN (RSN) | 32	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	MUX 36D08
MUX36D08IRSNR.B	Active	Production	QFN (RSN) | 32	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	MUX 36D08
MUX36D08IRSNRG4	Active	Production	QFN (RSN) | 32	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	MUX 36D08
MUX36D08IRSNRG4.B	Active	Production	QFN (RSN) | 32	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	MUX 36D08
MUX36D08IRTVR	Active	Production	WQFN (RTV) | 32	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	MUX 36D08
MUX36D08IRTVR.B	Active	Production	WQFN (RTV) | 32	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	MUX 36D08
MUX36S16IDWR	Active	Production	SOIC (DW) | 28	1000 | LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36S16DA
MUX36S16IDWR.B	Active	Production	SOIC (DW) | 28	1000 | LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36S16DA
MUX36S16IPW	Active	Production	TSSOP (PW) | 28	50 | TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36S160A
MUX36S16IPW.B	Active	Production	TSSOP (PW) | 28	50 | TUBE	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36S160A
MUX36S16IPWR	Active	Production	TSSOP (PW) | 28	2000 | LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36S160A
MUX36S16IPWR.B	Active	Production	TSSOP (PW) | 28	2000 | LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 125	MUX36S160A
MUX36S16IRSNR	Active	Production	QFN (RSN) | 32	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	MUX 36S16

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
MUX36S16IRSNR.B	Active	Production	QFN (RSN) | 32	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	MUX 36S16
MUX36S16IRSNRG4	Active	Production	QFN (RSN) | 32	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	MUX 36S16
MUX36S16IRSNRG4.B	Active	Production	QFN (RSN) | 32	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	MUX 36S16
MUX36S16IRTVR	Active	Production	WQFN (RTV) | 32	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	MUX 36S16
MUX36S16IRTVR.B	Active	Production	WQFN (RTV) | 32	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	MUX 36S16

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.